



SAMPLE APPLICATION

- CRS Real-Time Software Receiver Front End
- Snapshot Processing
- Receiver Development
- Signal Simulator Evaluation
- Multipath Monitoring

The Dual Frequency GPS Front End consists of a dual-frequency downconverter and an optional data acquisition system. The downconverter box downconverts L_1 and L_2 band signals to suitable IF frequencies, whose signals can then be digitized and stored in either a PC using the data acquisition card or the digital storage unit. The IF signal can also be used as a direct input to the real-time software correlators or other receivers.

These downconverters are developed using discrete components and provide excellent performance in terms of noise, gain, phase flatness, and overall reliability. Both AGC and fixed gain (digitally controlled) versions are available.

DUAL FREQUENCY FRONT END

OPERATING SPECIFICATIONS

TWO CHANNEL DOWNCONVERTER,, FIXED GAIN (DC-2-001-01)

Input Frequencies: 1575.42 MHz (L1)

1227.60 MHz (L2)

Input/Output Impedance: 500 Ohms, all ports except 10 MHz IN and 10 MHz OUT ports

I.F. Bandwidth (3 dB):

Gain: 70 dB, typical (attenuator set to 0 dB)

Attenuation Ranger: 30 dB with 2 dB steps, user-selected at each channel

Gain Flatness: $\pm 1 \text{ dB}$

Noise Figure: 4.5 dB, typical

Output 1 dB Compression: ± 10 dBm, typical

Final I.F. Output: 13.991429 MHz (L1)

16.600000 MHz (L2)

Antenna Power: 12 VDC @ 50 mA, maximum current

Reference Frequency:

Reference Stability: ± 0.020 ppm

Reference Warm Up:

Reference Phase Noise:
-35 dBc/Hz @ 1 Hz
(Typical)
-115 dBc/Hz @ 10 Hz

-155 dBc/Hz @ 1 KHz

External Reference: $10 \text{ MHz} \pm 1 \text{ KHz}$, TTL compatible

Power Requirements: + 12 VDC +/-5%, 520 mA after warm-up

+ 12 VDC +/-5%, 750 mA during warm-up

- 12 VDC +/-5%, 80 mA

Operating Temperature: 0° to 50° C

Housing Dimensions: 4.00" X 6.00" X 0.9"

R.F. Connections:

Power Connections:Solder terminals

DUAL FREQUENCY FRONT END

OPERATING SPECIFICATIONS

TWO CHANNEL DOWNCONVERTER WITH AGC (DC-2-007-04)

Input Frequencies: $1575.42 \text{ MHz} (L_1)$

 $1227.60 \text{ MHz} (L_2)$

Input/Output Impedance: 500 Ohms, all ports except 10 MHz IN and 10 MHz OUT ports

I.F. Bandwidth (3 dB):

Gain: 90 dB, typical (attenuator set to 0 dB)

Output AGC Point: $0 \text{ dBm} \pm 1 \text{ dBm}$

AGC Range:

Gain Flatness: $\pm 1 dB$

Noise Figure: 4.5 dB, typical

Output 1 dB Compression: \pm 10 dBm, typical

Final I.F. Output: 13.991429 MHz (L1)

16.600000 MHz (L2)

Antenna Power: 12 VDC @ 50 mA, maximum current

Reference Frequency:

Reference Stability: $\pm 0.020 \text{ ppm}$

Reference Warm Up:

Reference Phase Noise:
-85 dBc/Hz @ 1 Hz
-115 dBc/Hz @ 10 Hz

-155 dBc/Hz @ 1 KHz

External Reference: $10 \text{ MHz} \pm 1 \text{ KHz}$, TTL compatible

Power Requirements: +12 VDC +/-5%, 520 mA after warm-up

+12 VDC +/-5%, 750 mA during warm-up

-12 VDC +/-5%, 80 mA

Operating Temperature: 0° to 50° C

Storage Temperatures: -40° to $+60^{\circ}$ C

Relative Humidity: 95% maximum, non-condensing

Altitude: 0 - 5 km, maximum

Housing Dimensions: 4.00" X 6.00" X 0.9"

R.F. Connections:

Power Connections: Solder terminals

DUAL FREQUENCY FRONT END

DATA A	ACO	UISI '	TON
---------------	------------	---------------	-----

DL-2-007-04

Number of Bits

Number of Channels

ADC Sampling Clock 105, 80, etc. MHz

Decimation 1 to 16

Input Connector
SMA

External Trigger Signal 3.3 V TTL

Interface PCI Bus

Storage 300 MB in RAM

ALSO AVAILABLE:

- Hard Disk Recording System: For data storage up to 1 to 3 hours
- FPGA Accelerated Correlator: For pre-processing and real-time operation
- Modular Software GPS Receiver: Interfaces directly with the Front End for an entirely software-based operation or through FPGA correlator for real-time operation
- Single Frequency RF Front End: For C/A code operation
- Multiple Antenna RF Front End: For beamforming, multipath monitoring, and mitigations as well as other STAP processing
- Satellite Beacon Receivers: 150 MHz/400 MHz RF Front Ends. Programmable Los allow easy adaptation to any frequency plan. Specialized adaptation with various Front End, A/D conversion, interface card, storage, and other relevant subassemblies.